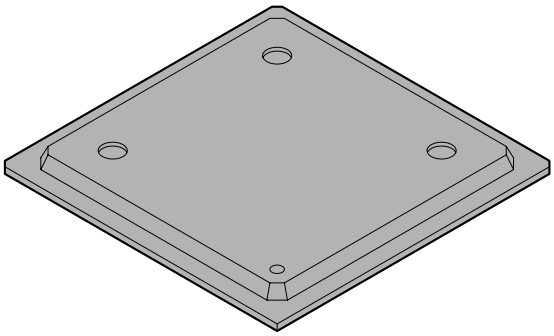
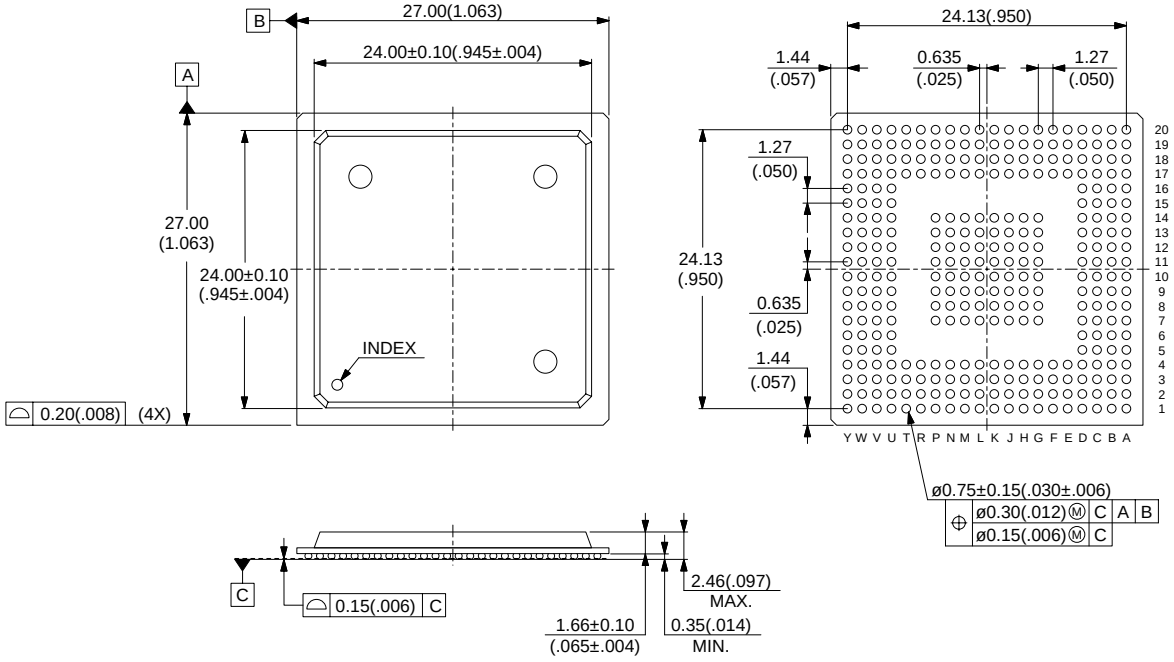
PLASTIC BALL GRID ARRAY PACKAGE
320 PIN PLASTIC

BGA-320P-M06

320-pin plastic PBGA  (BGA-320P-M06)	Lead pitch	1.27 mm
	Package width × package length	27.00 mm × 27.00 mm
	Lead shape	Ball
	Sealing method	Plastic mold
	Mounting height	2.46 mm Max
	Weight	2.90 g

320-pin plastic PBGA
(BGA-320P-M06)



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Dimensions in mm (inches).
Note: The values in parentheses are reference values.

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